

E0520CIP

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Commissioner for Patents, P.O. Box 1450  
Alexandria, VA 22313-1450, on Sept 9/2003  
Deborah W. Wendour

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Applicant: K. Sahota, D. Schonauer, J. Groschopf, )  
G. Marxsen, and S. Avanzino, ) Grp Art Unit: 1765  
)  
Assignee: Advanced Micro Devices, Inc. ) Exam: L. Umez Eronini  
)  
Serial Number: 09/749,191 )  
)  
Filed: December 26, 2000 )  
)  
For: PREVENTION OF PRECIPITATION )  
DEFECTS ON COPPER INTER- )  
CONNECTS DURING CMP BY USE )  
OF SOLUTIONS CONTAINING )  
ORGANIC COMPOUNDS WITH )  
SILICA ADSORPTION AND COPPER )  
CORROSION INHIBITING )  
PROPERTIES )  
)

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR RECONSIDERATION AND**  
**REQUEST TO WITHDRAW THE FINAL REJECTION**

Dear Sir,

This is in response to the Office Action mailed on July 22, 2003. Applicant notes that this reply falls within the two month period for timely Advisory Action. Applicant respectfully requests that the arguments herein be fully considered.